

Atty Docket No.: M4065.067/P067

Applicant: Warren Farnworth et al.

Serial No.: 09/118,080

Filing Date: July 17, 1998

Title: TAPED SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURE

Documents Filed: Information Disclosure Statement, Form PTO 1449, and 8 References

Sender's Initials: MJT/MC/tas

Date: August 19, 1998

PATENT

Docket No.: M4065.067/P067

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of
Warren M. Farnworth

Serial No.: 09/118,080

Art Unit: 2811

Filed: July 17, 1998

Examiner: Not Yet Assigned

For: TAPED SEMICONDUCTOR DEVICE AND METHOD OF
MANUFACTURE

Assistant Commissioner for Patents
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT (IDS)

Dear Sir:

Pursuant to 37 C.F.R. 1.56, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO-1449. A copy of each reference is attached. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

- ☒ 1. This Information Disclosure Statement is being filed within three months of the U.S. filing date OR within three months of the date of entry of the national stage as set forth in 37 C.F.R. 1.491, OR before the mailing date of a first Office Action on the merits, whichever event occurs last. No certification or fee is required. 37 C.F.R. 1.97(b).
- ☐ 2. This Information Disclosure Statement is being filed more than three months after the U.S. filing date, OR more than three months after the date of entry of the national stage, AND after the mailing date of the first Office Action on the merits, whichever occurs first, but before the mailing date of a Final rejection or Notice of Allowance. 37 C.F.R. 1.97(c).



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- _____ a. I hereby certify that each item or information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement. 37 C.F.R. 1.97(e)(1).
- _____ b. I hereby certify that no item of information in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 37 C.F.R. 1.56(c) more than three months prior to the filing of this Information Disclosure Statement. 37 C.F.R. 1.97(e)(2).
- _____ c. Attached is our check in the amount of _____ in payment of the fee under 37 C.F.R. 1.17(p). Please charge any fee deficiencies, or credit any overpayment, to Deposit Account No. 04-1073 as needed to ensure consideration of the Information Disclosure Statement. Two duplicate copies of this paper are attached.
- _____ 3. This Information Disclosure Statement is being filed more than three months after the U.S. filing date, OR more than three months after the date of entry of the national stage, AND after the mailing date of a Final Rejection or Notice of Allowance, but before payment of the Issue Fee. Applicant(s) hereby petition(s) that the Information Disclosure Statement be considered. Attached is our check in the amount of _____ in payment of the petition fee under 37 C.F.R. 1.17(i)(1). Please credit or debit Deposit Account No. 04-1073 as needed to ensure consideration of the Information Disclosure Statement. Two duplicate copies of this paper are attached.
- _____ a. I hereby certify that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement. 37 C.F.R. 1.97(e)(1).
- _____ b. I hereby certify that no item of information in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 37 C.F.R. 1.56(c) more than three months prior to the filing of this Information Disclosure Statement. 37 C.F.R. 1.97(e)(2).

____ 4. Translations of the non-English language references are enclosed.

____ full

____ partial

____ summary/abstract

____ 5. A copy of a foreign application communication from a related foreign application discussing the relevancy of the references is attached.

Dated: August 18, 1998

Respectfully submitted,

By 

Mark J. Thronson

Registration No. 33,082

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Washington, D.C. 20037-1526

202-785-9700

Attorneys for Applicant

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

Docket Number (Optional)

M4065.067/1005

Application Number

09/118,080

Applicant(s)

Warren M. Farnworth

Filing Date

July 17, 1998

Group Art Unit

2814
Not Yet Assigned

U.S. PATENT DOCUMENTS

| *EXAMINER INITIAL | REF | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
|----------------------|-----|-----------------|---------|------------------|-------|----------|-------------------------------|
| AC | A | 5,731,231 | 3/24/98 | Miyajima | | | |
| AC | B | 5,391,918 | 2/21/95 | Koyanagi et al. | | | |
| AC | C | 5,218,168 | 6/8/93 | Mitchell et al. | | | |
| AC | D | 4,906,314 | 3/6/90 | Farnworth et al. | | | |
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FOREIGN PATENT DOCUMENTS

| | REF | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | Translation | |
|--|-----|-----------------|------|---------|-------|----------|-------------|----|
| | | | | | | | YES | NO |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

| | | |
|----|---|--|
| AC | E | L Platform SMT Printers For The Real World Brochure |
| | F | DEK 265 Next Generation High Performance Surface Mount Screen Print Brochure |
| AC | G | Technical Data Sheet: Master Bond Polymer System EP31 |
| | H | Master Bond Problem Solver Brochure |

EXAMINER

2811 2814 *Alonzo Chambliss*

DATE CONSIDERED

10/8/00

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.